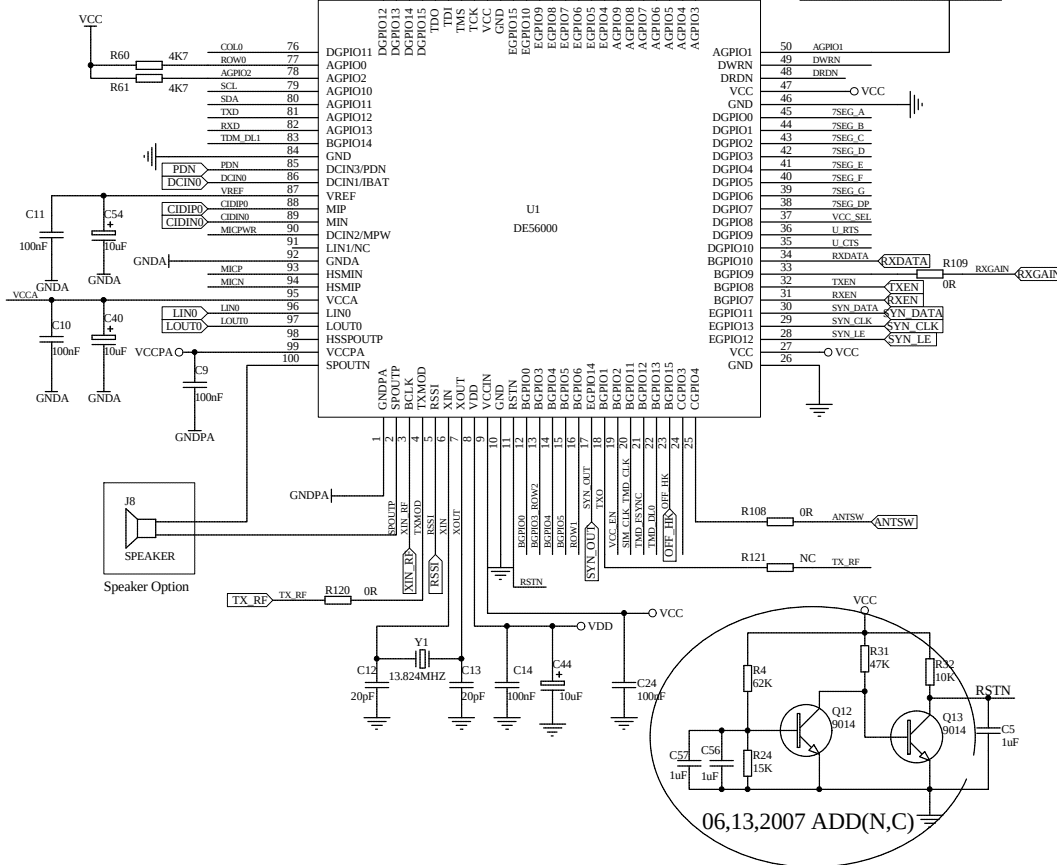
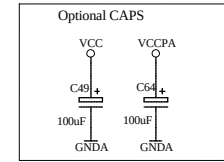
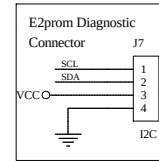
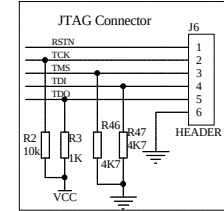
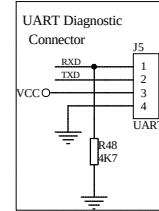
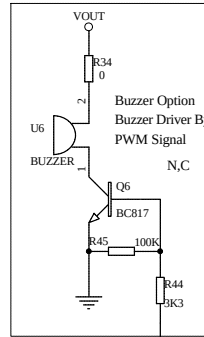
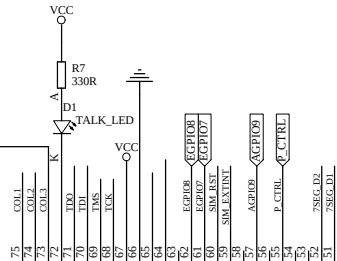
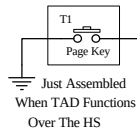
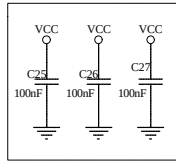
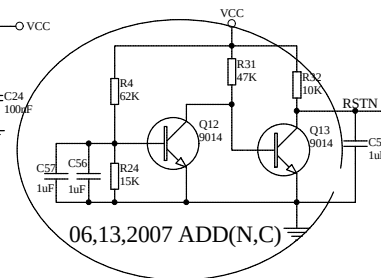
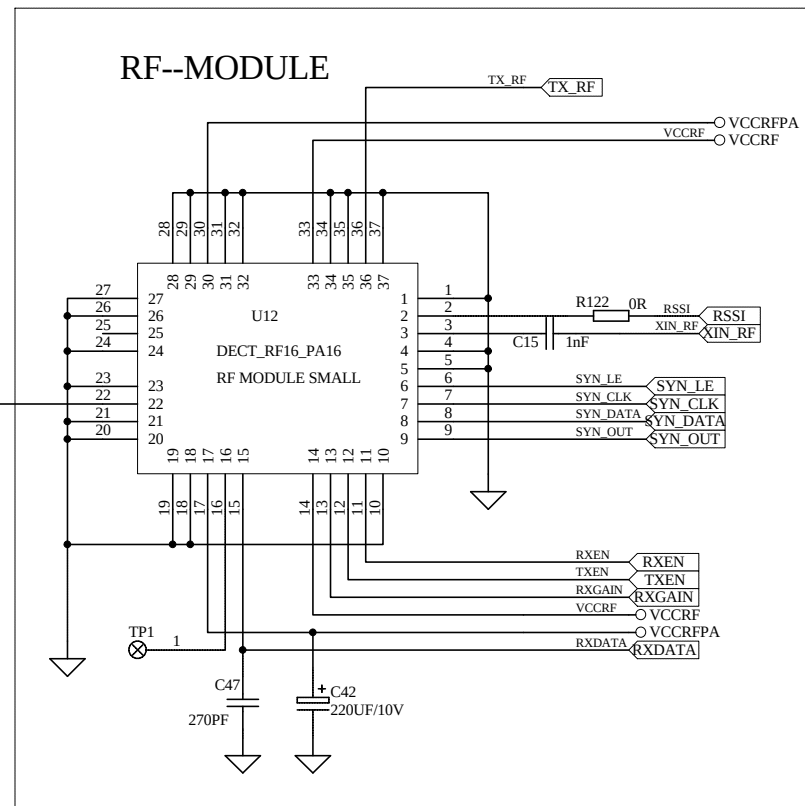
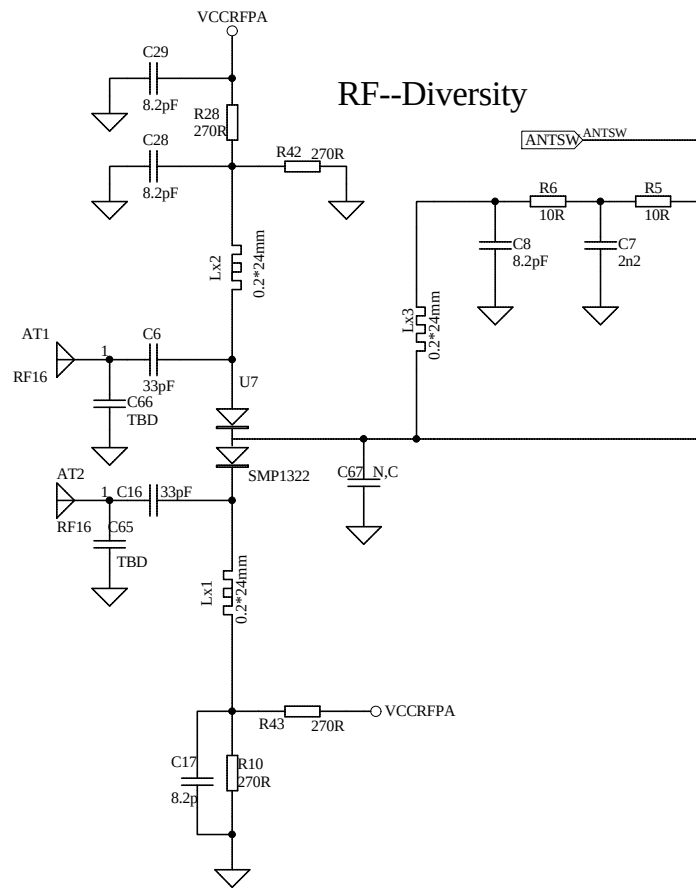


For CID Model With DEV CHIP A 4MB Flash Should Be Used (AT45DB041B)
 For TAD Model With DEV CHIP A 16MB Flash Should Be Used (AT45DB161B)
 For TAD Model With Mask Has To Be Use A 4MB Flash(AT45DB041B)



Xingtel XIAMEN XINGLIAN ELECTRONICS CO.,LTD.			
TITLE	CL-3307 BASE MCU		
DWG NO			
DESIGN	Paul	APPROVE	
CHECK		DATE	Feb,08,2007
REV.	V1.0	SCALE FIT	SHEET OF



Xingtel XIAMEN XINGLIAN ELECTRONICS CO.,LTD.			
TITLE	CL-3307 BASE RF		
DWG NO			
DESIGN	Paul	APPROVE	
CHECK		DATE	Feb,08,2007
REV.	V1.0	SCALE FIT	SHEET OF